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# FAN54010 / FAN54011 / FAN54012 / FAN54013 / FAN54014 USB-Compliant Single-Cell Li-lon Switching Charger with USB-OTG Boost Regulator

### **Features**

- Fully Integrated, High-Efficiency Charger for Single-Cell Li-Ion and Li-Polymer Battery Packs
- Faster Charging than Linear
- Charge Voltage Accuracy: ±0.5% at 25°C

±1% from 0 to 125°C

- ±5% Input Current Regulation Accuracy
- ±5% Charge Current Regulation Accuracy
- 20 V Absolute Maximum Input Voltage
- 6 V Maximum Input Operating Voltage
- 1.45 A Maximum Charge Rate
- Programmable through High-Speed I<sup>2</sup>C Interface (3.4 Mb/s) with Fast Mode Plus Compatibility
  - Input Current
  - Fast-Charge / Termination Current
  - Charger Voltage
  - Termination Enable
- 3 MHz Synchronous Buck PWM Controller with Wide Duty Cycle Range
- Small Footprint 1μH External Inductor
- Safety Timer with Reset Control
- 1.8 V Regulated Output from VBUS for Auxiliary Circuits
- Weak Input Sources Accommodated by Reducing Charging Current to Maintain Minimum VBUS Voltage
- Low Reverse Leakage to Prevent Battery Drain to VBUS
- 5 V, 500 mA Boost Mode for USB OTG for 3.0 V to 4.5 V Battery Input

### **Applications**

- Cell Phones, Smart Phones, PDAs
- Tablet, Portable Media Players
- Gaming Device, Digital Cameras

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### Description

The FAN54010 family (FAN5401X) combines a highly integrated switch-mode charger, to minimize single-cell Lithiumion (Li-ion) charging time from a USB power source, and a boost regulator to power a USB peripheral from the battery.

The charging parameters and operating modes are programmable through an I<sup>2</sup>C Interface that operates up to 3.4 Mbps. The charger and boost regulator circuits switch at 3MHz to minimize the size of external passive components.

The FAN5401X provides battery charging in three phases: conditioning, constant current, and constant voltage.

To ensure USB compliance and minimize charging time, the input current is limited to the value set through the  $I^2C$  host. Charge termination is determined by a programmable minimum current level. A safety timer with reset control provides a safety backup for the  $I^2C$  host.

The integrated circuit (IC) automatically restarts the charge cycle when the battery falls below an internal threshold. If the input source is removed, the IC enters a high-impedance mode with leakage from the battery to the input prevented. Charge status is reported back to the host through the I<sup>2</sup>C port. Charge current is reduced when the die temperature reaches 120°C.

The FAN5401X can operate as a boost regulator on command from the system. The boost regulator includes a soft-start that limits inrush current from the battery.

The FAN5401X is available in a 1.96 x 1.87 mm, 20-bump, 0.4 mm pitch, WLCSP package.

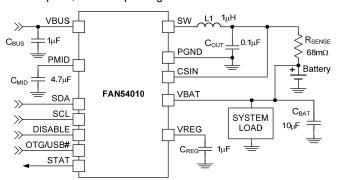


Figure 1. Typical Application

### **Ordering Information**

Part Number	Temperature Range	Package	PN Bits: IC_INFO[4:2]	Packing Method
FAN54010UCX <sup>(1)</sup>	-40 to 85°C	20-Bump, Wafer-Level	011	Tape and Reel
FAN54011UCX <sup>(1)</sup>	-40 to 85°C	Chip-Scale Package	001	Tape and Reel
FAN54012UCX <sup>(1)</sup>	-40 to 85°C	(WLCSP), 0.4 mm Pitch,	011	Tape and Reel
FAN54013UCX	-40 to 85°C	Estimated Size:	101	Tape and Reel
FAN54014UCX <sup>(1)</sup>	-40 to 85°C	1.96 x 1.87 mm	111	Tape and Reel

#### Note:

**Table 1. Feature Comparison Summary** 

Part Number	PN Bits: REG3[4:2]	Slave Address	Automatic Charge	Special Charger <sup>(2)</sup>	Safety Limits	Battery Absent Behavior	E2 Pin	VREG (E3 Pin)
FAN54010UCX	011	1101011	Yes	No	No	OFF	AUXPWR (Connect	k:
FAN54011UCX	001	1101011	No	No	No	OFF		PMID
FAN54012UCX	011	1101011	Yes	No	No	ON	to VBAT)	
FAN54013UCX	101	1101011	Yes	Yes	Yes	OFF	DISABLE	1.8V
FAN54014UCX	111	1101011	No	Yes	Yes	OFF	DISABLE	1.00

#### Note:

**Table 2. Recommended External Components** 

Component	Description	Vendor	Parameter	Тур.	Unit
L1	1 μH ±20%, 1.6 A DCR=55 mΩ, 2520	Murata: LQM2HPN1R0		1.0	
	1 μH ±30%, 1.4A DCR=85 mΩ, 2016	Murata: LQM2MPN1R0	L	1.0	μН
Сват	10 μF, 20%, 6.3 V, X5R, 0603	Murata: GRM188R60J106M TDK: C1608X5R0J106M	С	10	μF
C <sub>MID</sub>	4.7 μF, 10%, 6.3 V, X5R, 0603	Murata: GRM188R60J475K TDK: C1608X5R0J475K	C <sup>(3)</sup>	4.7	μF
C <sub>BUS</sub>	1.0 μF, 10%, 25 V, X5R, 0603	Murata GRM188R61E105K TDK:C1608X5R1E105M	С	1.0	μF

#### Note

3. A 6.3 V rating is sufficient for C<sub>MID</sub> since PMID is protected from over-voltage surges on VBUS by Q3 (Figure 3).

<sup>1.</sup> Preliminary release only; please contact a Fairchild representative for information about part availability.

<sup>2.</sup> A "special charger" is a current-limited charger that is not a USB compliant source.

### **Block Diagram**

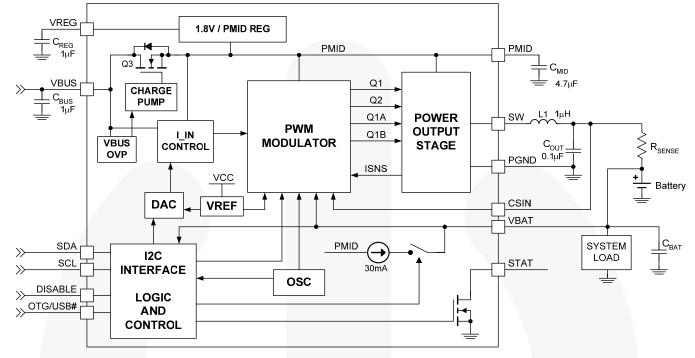
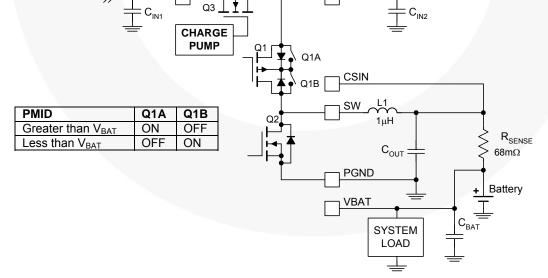


Figure 2. IC and System Block Diagram

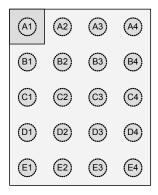
**PMID** 

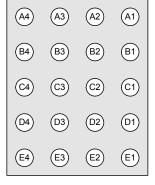


**VBUS** 

Figure 3. Power Stage

### **Pin Configuration**





**Top View** 

**Bottom View** 

Figure 4. WLCSP-20 Pin Assignments

### **Pin Definitions**

Pin#	Name	Part #	Description
A1, A2	VBUS	ALL	Charger Input Voltage and USB-OTG output voltage. Bypass with a 1 µF capacitor to PGND.
А3	NC	ALL	No Connect. No external connection is made between this pin and the IC's internal circuitry.
A4	SCL	ALL	I <sup>2</sup> C Interface Serial Clock. This pin should not be left floating.
B1-B3	PMID	ALL	<b>Power Input Voltage</b> . Power input to the charger regulator, bypass point for the input current sense, and high-voltage input switch. Bypass with a minimum of 4.7 $\mu$ F, 6.3 V capacitor to PGND.
B4	SDA	ALL	I <sup>2</sup> C Interface Serial Data. This pin should not be left floating.
C1-C3	SW	ALL	Switching Node. Connect to output inductor.
C4	STAT	ALL	Status. Open-drain output indicating charge status. The IC pulls this pin LOW when charging.
D1-D3	PGND	ALL	<b>Power Ground</b> . Power return for gate drive and power transistors. The connection from this pin to the bottom of C <sub>MID</sub> should be as short as possible.
D4	OTG	ALL	<b>On-The-Go</b> . Enables boost regulator in conjunction with OTG_EN and OTG_PL bits (see Table 16). On VBUS Power-On Reset (POR), this pin sets the input current limit for t <sub>15MIN</sub> charging.
E1	CSIN	ALL	Current-Sense Input. Connect to the sense resistor in series with the battery. The IC uses this node to sense current into the battery. Bypass this pin with a $0.1 \mu F$ capacitor to PGND.
E2	AUXPWR	10, 11, 12	<b>Auxiliary Power</b> . Connect to the battery pack to provide IC power during High-Impedance Mode. Bypass with a 1 μF capacitor to PGND.
E2	DISABLE	13, 14,	<b>Charge Disable</b> . If this pin is HIGH, charging is disabled. When LOW, charging is controlled by the I <sup>2</sup> C registers. When this pin is HIGH, the 15-minute timer is reset. This pin does not affect the 32-second timer.
E3	VREG	ALL	Regulator Output. Connect to a 1 $\mu$ F capacitor to PGND. This pin can supply up to 2 mA of DC load current. For FAN54010-FAN54012, the output voltage is PMID, which is limited to 6.5 V. For FAN54013-FAN54014, the output voltage is regulated to 1.8 V.
E4	VBAT	ALL	<b>Battery Voltage</b> . Connect to the positive (+) terminal of the battery pack. Bypass with a 0.1 μF capacitor to PGND if the battery is connected through long leads.

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Parai	meter	Min.	Max.	Unit
V	VPLIC Voltage	Con	tinuous	-1.4	20.0	V
$V_{BUS}$	VBUS Voltage	Puls	sed, 100 ms Maximum Non-Repetitive	-2.0	20.0	V
$V_{STAT}$	STAT Voltage			-0.3	16.0	V
Vı	PMID Voltage				7.0	V
۷ı	SW, CSIN, VBAT, AUXPWR, DISABLE Voltage			-0.3	7.0	V
Vo	Voltage on Other Pins			-0.3	6.5 <sup>(4)</sup>	V
$\frac{\text{dV}_{\text{BUS}}}{\text{dt}}$	Maximum V <sub>BUS</sub> Slope above	5.5 V whe	n Boost or Charger are Active		4	V/μs
ESD	Electrostatic Discharge	Hum	nan Body Model per JESD22-A114	20	000	V
ESD	Protection Level	Cha	rged Device Model per JESD22-C101	5	00	V
TJ	Junction Temperature			-40	+150	°C
T <sub>STG</sub>	Storage Temperature			-65	+150	°C
TL	Lead Soldering Temperature	, 10 Secor	nds		+260	°C

#### Note:

4. Lesser of 6.5 V or V<sub>I</sub> + 0.3 V.

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Min.	Max.	Unit
V <sub>BUS</sub>	upply Voltage		4	6	V
$V_{BAT(MAX)}$	Maximum Battery Voltage when Boost enabled	aximum Battery Voltage when Boost enabled			V
dV <sub>BUS</sub>	regative vibes slow reads during vibes short should,	A ≤ 60°C		4	\//a
dt	C <sub>MID</sub> ≤ 4.7 µF (see VBUS Short While Charging)	A ≥ 60°C		2	V/μs
T <sub>A</sub>	mbient Temperature		-30	+85	°C
TJ	Junction Temperature (see Thermal Regulation and Protection	n section)	-30	+120	°C

### **Thermal Properties**

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature  $T_{J(max)}$  at a given ambient temperature  $T_A$ . For measured data, see Table 11.

Symbol	Parameter	Typical	Unit
θЈА	Junction-to-Ambient Thermal Resistance	60	°C/W
$\theta_{JB}$	Junction-to-PCB Thermal Resistance	20	°C/W

### **Electrical Specifications**

Unless otherwise specified: according to the circuit of Figure 1; recommended operating temperature range for  $T_J$  and  $T_A$ ;  $V_{BUS}$ =5.0 V;  $HZ_MODE$ ;  $QPA_MODE$ 0; (Charge Mode);  $QPA_MODE$ 0;  $QPA_MODE$ 10;  $QPA_MODE$ 20;  $QPA_MODE$ 30;  $QPA_MODE$ 40;  $QPA_MODE$ 400;  $QPA_MODE$ 40;  $QPA_MODE$ 40;

Symbol	Parameter	Condi	Min.	Тур.	Max.	Unit		
Power Supp	lies			l				
		$V_{BUS} > V_{BUS(min)}$ , PW	M Switching		10		mA	
$I_{VBUS}$	VBUS Current	V <sub>BUS</sub> > V <sub>BUS(min)</sub> ; PW Not Switching (Batte Condition); I_IN Set	ery OVP		2.5		mA	
		$0^{\circ}\text{C} < \text{T}_{\text{J}} < 85^{\circ}\text{C}, \text{Hz}$ $\text{V}_{\text{BAT}} < \text{V}_{\text{LOWV}}, 32\text{S} \text{ M}$			63	90	μА	
$I_{LKG}$	VBAT to VBUS Leakage Current	0°C < T <sub>J</sub> < 85°C, HZ V <sub>BAT</sub> =4.2 V, V <sub>BUS</sub> =0	Z_MODE=1, V		0.2	5.0	μА	
	Battery Discharge Current in High-	0°C < T <sub>J</sub> < 85°C, HZ V <sub>BAT</sub> =4.2 V	Z_MODE=1,			20	^	
I <sub>BAT</sub>	Impedance Mode	FAN54013-14, DISA 0°C < T <sub>J</sub> < 85°C, V <sub>B</sub>				10	μА	
Charger Vol	tage Regulation							
	Charge Voltage Range			3.5		4.4		
$V_{OREG}$	Charge Voltage Accuracy	T <sub>A</sub> =25°C		-0.5%		+0.5%	V	
	Charge Vollage Accuracy	T <sub>J</sub> =0 to 125°C		-1%		+1%		
Charging Cu	urrent Regulation							
	Output Charge Current Range	$V_{LOWV} < V_{BAT} < V_{OREG}$ R <sub>SENSE</sub> =68m $\Omega$		550		1450	mA	
		20 mV < V <sub>IREG</sub> <	FAN54010-12	95	100	105	- %	
OCHRG	Charge Current Accuracy Across R <sub>SENSE</sub>	40 mV	FAN54013-14	92	97	102		
		V <sub>IREG</sub> > 40 mV	FAN54010-12	97	100	103		
			FAN54013-14	94	97	100		
Weak Batter	y Detection							
	Weak Battery Threshold Range			3.4		3.7	V	
$V_{LOWV}$	Weak Battery Threshold Accuracy			<b>–</b> 5		+5	%	
	Weak Battery Deglitch Time	Rising Voltage			30		ms	
Logic Levels	s: DISABLE, SDA, SCL, OTG					/		
V <sub>IH</sub>	High-Level Input Voltage			1.05	<i></i>		V	
V <sub>IL</sub>	Low-Level Input Voltage					0.4	V	
I <sub>IN</sub>	Input Bias Current	Input Tied to GND o	r V <sub>IN</sub>		0.01	1.00	μА	
Charge Tern	mination Detection	•						
	Termination Current Range	V <sub>BAT</sub> > V <sub>OREG</sub> - V <sub>RCH</sub>	, R <sub>SENSE</sub> =68 m $\Omega$	50		400	mA	
	T	[V <sub>CSIN</sub> – V <sub>BAT</sub> ] from	3 mV to 20 mV	-25		+25	61	
$I_{(TERM)}$	Termination Current Accuracy	[V <sub>CSIN</sub> - V <sub>BAT</sub> ] from 20 mV to 40 mV		<b>-</b> 5		+5	mA % V % ms	
	Termination Current Deglitch Time	2 mV Overdrive			30		ms	
1.8V Linear	Regulator	· ·			Ī.	1		
V <sub>REG</sub>	1.8 V Regulator Output	I <sub>REG</sub> from 0 to 2 mA,	FAN54013-14	1.7	1.8	1.9	V	

Continued on the following page...

### **Electrical Specifications**

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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Input Power	Source Detection		JI.		1	
V <sub>IN(MIN)1</sub>	VBUS Input Voltage Rising	To Initiate and Pass VBUS Validation		4.29	4.42	V
V <sub>IN(MIN)2</sub>	Minimum VBUS During Charge	During Charging		3.71	3.94	V
t <sub>VBUS_VALID</sub>	VBUS Validation Time			30		ms
Special Cha	rger (V <sub>BUS</sub> ) (FAN54013, FAN54014)			•	•	
V <sub>SP</sub>	Special Charger Setpoint Accuracy		-3		+3	%
Input Currer	nt Limit			•	•	_
I <sub>INLIM</sub>	Input Current Limit Threshold	I <sub>IN</sub> Set to 100 mA	88 450	93 475	98 500	mA
V <sub>REF</sub> Bias Ge	enerator					
	Bias Regulator Voltage	$V_{BUS} > V_{IN(MIN)}$ or $V_{BAT} > V_{BAT(MIN)}$			6.5	V
$V_{REF}$	Short-Circuit Current Limit			20		mA
Battery Recl	harge Threshold					_!
	Recharge Threshold	Below V <sub>(OREG)</sub>	100	120	150	mV
$V_{RCH}$	Deglitch Time	V <sub>BAT</sub> Falling Below V <sub>RCH</sub> Threshold		130		ms
STAT Outpu	it					.1
V <sub>STAT(OL)</sub>	STAT Output Low	I <sub>STAT</sub> =10 mA			0.4	V
I <sub>STAT(OH)</sub>	STAT High Leakage Current	V <sub>STAT</sub> =5 V			1	μА
Battery Dete	ection			1		
I <sub>DETECT</sub>	Battery Detection Current before Charge Done (Sink Current) <sup>(5)</sup>	Begins after Termination Detected		-0.80		mA
t <sub>DETECT</sub>	Battery Detection Time	and V <sub>BAT</sub> ≤ V <sub>OREG</sub> –V <sub>RCH</sub>		262		ms
Sleep Comp	arator					
$V_{SLP}$	Sleep-Mode Entry Threshold, V <sub>BUS</sub> – V <sub>BAT</sub>	$2.3 \text{ V} \leq \text{V}_{\text{BAT}} \leq \text{V}_{\text{OREG}}, \text{V}_{\text{BUS}} \text{ Falling}$	0	0.04	0.10	V
t <sub>SLP_EXIT</sub>	Deglitch Time for VBUS Rising Above V <sub>BAT</sub> by V <sub>SLP</sub>	Rising Voltage		30		ms
Power Switch	ches (see Figure 3)			7		
	Q3 On Resistance (VBUS to PMID)	I <sub>IN(LIMIT)</sub> =500 mA		180	250	
$R_{DS(ON)}$	Q1 On Resistance (PMID to SW)			130	225	mΩ
	Q2 On Resistance (SW to GND)			150	225	
Charger PW	M Modulator					
f <sub>SW</sub>	Oscillator Frequency		2.7	3.0	3.3	MHz
D <sub>MAX</sub>	Maximum Duty Cycle				100	%
D <sub>MIN</sub>	Minimum Duty Cycle			0		%
I <sub>SYNC</sub>	Synchronous to Non-Synchronous Current Cut-Off Threshold <sup>(6)</sup>	Low-Side MOSFET (Q2) Cycle-by- Cycle Current Limit		140		mA

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### **Electrical Specifications**

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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Boost Mode	Operation (OPA_MODE=1, HZ_MODE	DE=0)	•			
1/	Boost Output Voltage at VBUS	$2.5 \text{ V} < \text{V}_{\text{BAT}} < 4.5 \text{ V}, \text{ I}_{\text{LOAD}} \text{ from 0 to}$ 200 mA	4.80	5.07	5.17	V
$V_{BOOST}$	Boost Output Voltage at VBOS	$3.0 \text{ V} < \text{V}_{\text{BAT}} < 4.5 \text{ V}, \text{ I}_{\text{LOAD}} \text{ from 0 to}$ 500 mA	4.77	5.07	5.17	- V
I <sub>BAT(BOOST)</sub>	Boost Mode Quiescent Current	PFM Mode, V <sub>BAT</sub> =3.6 V, I <sub>OUT</sub> =0		140	300	μА
I <sub>LIMPK(BST)</sub>	Q2 Peak Current Limit		1272	1590	1908	mA
11//1.0	Minimum Battery Voltage for Boost	While Boost Active		2.42		V
UVLO <sub>BST</sub>	Operation	To Start Boost Regulator		2.58	2.70	7 °
VBUS Load	Resistance					
В	VBUS to PGND Resistance	Normal Operation		1500		ΚΩ
R <sub>VBUS</sub>	VBOS to PGND Resistance	Charger Validation		100		Ω
Protection a	nd Timers					
VBUS <sub>OVP</sub>	VBUS Over-Voltage Shutdown	V <sub>BUS</sub> Rising	6.09	6.29	6.49	V
VBUS <sub>OVP</sub>	Hysteresis	V <sub>BUS</sub> Falling		100		mV
I <sub>LIMPK(CHG)</sub>	Q1 Cycle-by-Cycle Peak Current Limit	Charge Mode		2.3		Α
\/	Battery Short-Circuit Threshold	V <sub>BAT</sub> Rising	1.95	2.00	2.05	V
$V_{SHORT}$	Hysteresis	V <sub>BAT</sub> Falling		100		mV
I <sub>SHORT</sub>	Linear Charging Current	V <sub>BAT</sub> < V <sub>SHORT</sub>	20	30	40	mA
Т	Thermal Shutdown Threshold <sup>(7)</sup>	T <sub>J</sub> Rising		145		-°C
T <sub>SHUTDWN</sub>	Hysteresis <sup>(7)</sup>	T <sub>J</sub> Falling		10		
$T_CF$	Thermal Regulation Threshold <sup>(7)</sup>	Charge Current Reduction Begins		120		°C
t <sub>INT</sub>	Detection Interval			2.1		S
tono	32-Second Timer <sup>(8)</sup>	Charger Enabled	20.5	25.2	28.0	s
t <sub>32S</sub>	32-36cond Time	Charger Disabled	18.0	25.2	34.0	5
t <sub>15MIN</sub>	15-Minute Timer	15-Minute Mode (FAN54013-14)	12.0	13.5	15.0	min
$\Delta t_{LF}$	Low-Frequency Timer Accuracy	Charger Inactive	-25		25	%

#### Notes:

- 5. Negative current is current flowing from the battery to VBUS (discharging the battery).
- 6. Q2 always turns on for 60 ns, then turns off if current is below I<sub>SYNC</sub>.
- 7. Guaranteed by design; not tested in production.
- 8. This tolerance (%) applies to all timers on the IC, including soft-start and deglitching timers.

### I<sup>2</sup>C Timing Specifications

Guaranteed by design.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
		Standard Mode			100	
£	OOL Olask Francisco	Fast Mode			400	1.11_
$f_{SCL}$	SCL Clock Frequency	High-Speed Mode, C <sub>B</sub> ≤ 100 pF			3400	kHz
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF			1700	İ
	Bus-Free Time between STOP	Standard Mode		4.7		
t <sub>BUF</sub>	and START Conditions	Fast Mode		1.3		μS
		Standard Mode		4		μS
t <sub>HD;STA</sub>	START or Repeated START	Fast Mode		600		ns
Hold Time	noid Time	High-Speed Mode		160		ns
		Standard Mode		4.7		μ
		Fast Mode		1.3		μ\$
$t_{LOW}$	SCL LOW Period	High-Speed Mode, C <sub>B</sub> ≤ 100 pF		160		ns
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF		320		ns
		Standard Mode		4		μ
		Fast Mode		600		ns
t <sub>HIGH</sub>	SCL HIGH Period	High-Speed Mode, C <sub>B</sub> ≤ 100 pF		60		ns
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF	<b> </b>	120		ns
t <sub>SU;STA</sub>		Standard Mode		4.7		μ
	Repeated START Setup Time	Fast Mode		600		ns
-50,51A		High-Speed Mode		160		ns
		Standard Mode		250		
t <sub>SU;DAT</sub>	Data Setup Time	Fast Mode		100		ns
130,DA1	Data Cotap Timo	High-Speed Mode		10		
		Standard Mode	0		3.45	μ
		Fast Mode	0		900	ns
t <sub>HD;DAT</sub>	Data Hold Time	High-Speed Mode, C <sub>B</sub> ≤ 100 pF	0		70	ns
		High-Speed Mode, $C_B \le 400 \text{ pF}$	0		150	ns
		Standard Mode		).1C <sub>B</sub>	1000	
		Fast Mode		).1C <sub>B</sub>	300	
t <sub>RCL</sub>	SCL Rise Time	High-Speed Mode, C <sub>B</sub> ≤ 100 pF		10	80	ns
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF		20	160	
		Standard Mode	20+0	).1C <sub>B</sub>	300	1
		Fast Mode		).1C <sub>B</sub>	300	
$t_{FCL}$	SCL Fall Time	High-Speed Mode, C <sub>B</sub> ≤ 100 pF		10	40	ns
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF		20	80	
		Standard Mode	20+0	).1C <sub>B</sub>	1000	
too.	SDA Rise Time Rise Time of SCL after a	Fast Mode		).1C <sub>B</sub>	300	
t <sub>RDA</sub> t <sub>RCL1</sub>	Repeated START Condition	High-Speed Mode, C <sub>B</sub> ≤ 100 pF		10	80	ns
	and after ACK Bit	High-Speed Mode, C <sub>B</sub> ≤ 400 pF		20	160	

Continued on the following page...

### I<sup>2</sup>C Timing Specifications

Guaranteed by design.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
1		Standard Mode	20+0	).1C <sub>B</sub>	300		
	SDA Fall Time	Fast Mode	20+0	).1C <sub>B</sub>	300		
t <sub>FDA</sub>	SDA Fall Time	High-Speed Mode, C <sub>B</sub> ≤ 100 pF		10	80	ns	
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF		20	160		
		Standard Mode		4		μS	
t <sub>SU;STO</sub>	Stop Condition Setup Time	Fast Mode		600		ns	
		High-Speed Mode		160		ns	
Св	Capacitive Load for SDA, SCL				400	pF	

### **Timing Diagrams**

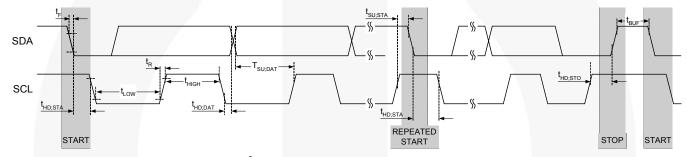
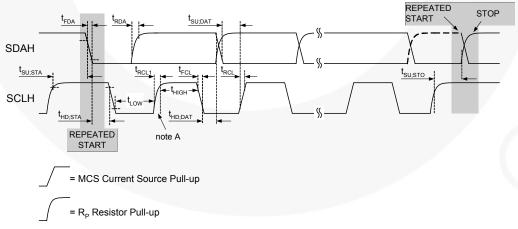


Figure 5. I<sup>2</sup>C Interface Timing for Fast and Slow Modes

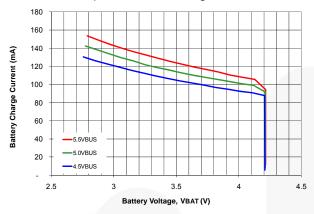


Note A: First rising edge of SCLH after Repeated Start and after each ACK bit.

Figure 6. I<sup>2</sup>C Interface Timing for High-Speed Mode

### **Charge Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1, V<sub>OREG</sub>=4.2 V, V<sub>BUS</sub>=5.0 V, and T<sub>A</sub>=25°C.



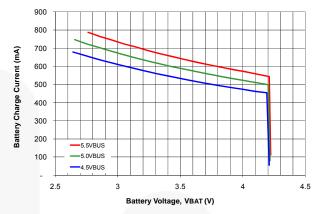


Figure 7. Battery Charge Current vs.  $V_{\text{BUS}}$  with  $I_{\text{INLIM}} = 100 \text{ mA}$ 

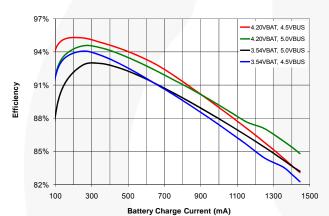


Figure 8. Battery Charge Current vs.  $V_{\text{BUS}}$  with  $I_{\text{INLIM}} = 500 \text{ mA}$ 

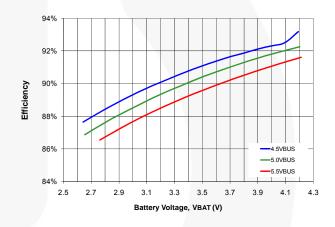


Figure 9. Charger Efficiency, No I<sub>INLIM</sub>, I<sub>OCHARGE</sub>=1,450 mA

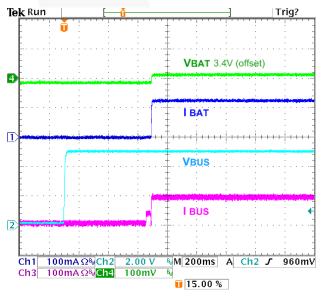


Figure 10. Charger Efficiency vs. V<sub>BUS</sub>, I<sub>INLIM</sub>=500 mA

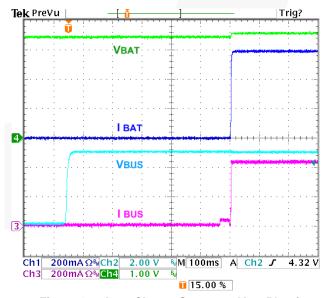


Figure 11. Auto-Charge Startup at  $V_{BUS}$  Plug-in,  $I_{INLIM}$ =100 mA, OTG=1,  $V_{BAT}$ =3.4 V

Figure 12. Auto-Charge Startup at  $V_{BUS}$  Plug-in,  $I_{INLIM}$ =500 mA, OTG=1,  $V_{BAT}$ =3.4 V

### **Charge Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1, V<sub>OREG</sub>=4.2 V, V<sub>BUS</sub>=5.0 V, and T<sub>A</sub>=25°C.

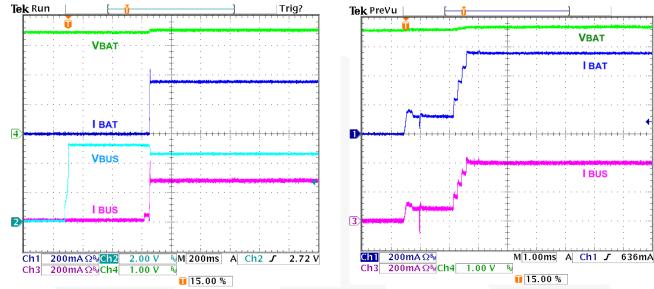


Figure 13. AutoCharge Startup with 300 mA Limited Charger / Adaptor, I<sub>INLIM</sub>=500 mA, OTG=1, V<sub>BAT</sub>=3.4 V

15.00 % Figure 14. Charger Startup with HZ\_MODE Bit Reset, I<sub>INLIM</sub>=500 mA, I<sub>OCHARGE</sub>=1,050 mA, OREG=4.2 V, V<sub>BAT</sub>=3.6 V

**VBAT** 

**IBAT** 

**I BUS** 

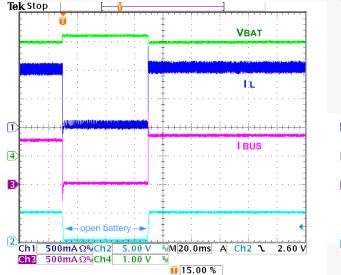


Figure 15. Battery Removal / Insertion During Charging, V<sub>BAT</sub>=3.9 V, I<sub>OCHARGE</sub>=1,050 mA, No I<sub>INLIM</sub>, TE=0

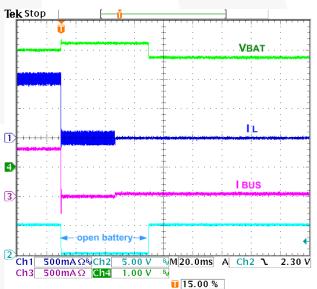
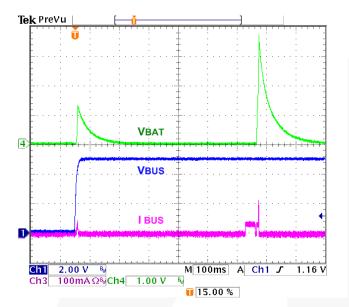


Figure 16. Battery Removal / Insertion During Charging, V<sub>BAT</sub>=3.9 V, I<sub>OCHARGE</sub>=1,050 mA, No I<sub>INLIM</sub>, TE=1

### **Charge Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1, V<sub>OREG</sub>=4.2 V, V<sub>BUS</sub>=5.0 V, and T<sub>A</sub>=25°C.



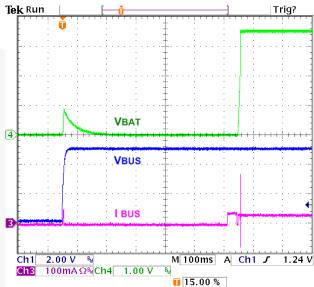
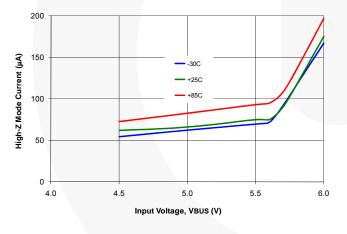


Figure 17. No Battery at V<sub>BUS</sub> Power-up; FAN54010, FAN54013





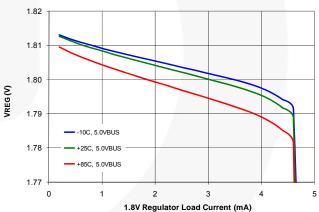
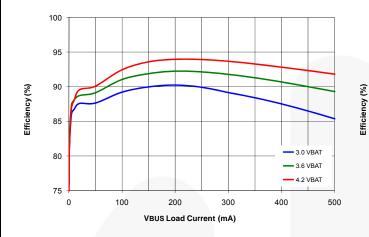


Figure 19. VBUS Current in High-Impedance Mode with Battery Open

Figure 20. V<sub>REG</sub> 1.8 V Output Regulation

### **Boost Mode Typical Characteristics**

Unless otherwise specified, using circuit of Figure 1, V<sub>BAT</sub>=3.6 V, T<sub>A</sub>=25°C.



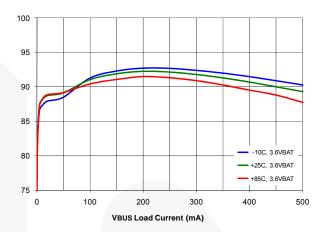


Figure 21. Efficiency vs. VBAT

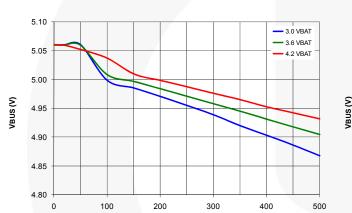


Figure 22. Efficiency Over Temperature

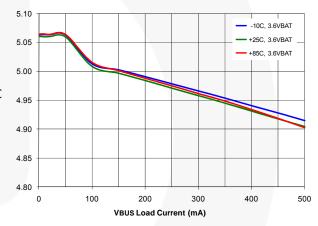


Figure 23. Output Regulation vs. V<sub>BAT</sub>

VBUS Load Current (mA)

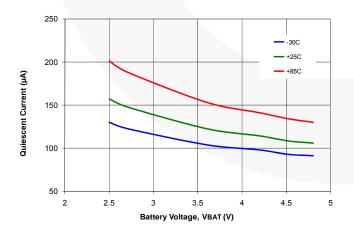


Figure 24. Output Regulation Over Temperature

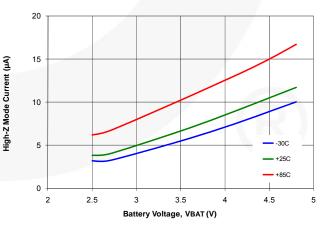


Figure 25. Quiescent Current

Figure 26. High-Impedance Mode Battery Current

### **Boost Mode Typical Characteristics**

Unless otherwise specified, using circuit of Figure 1, V<sub>BAT</sub>=3.6 V, T<sub>A</sub>=25°C.

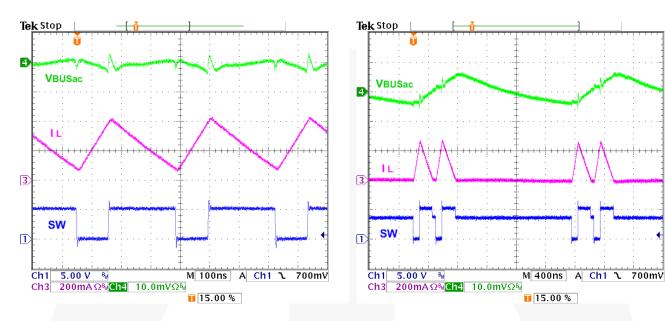


Figure 27. Boost PWM Waveform

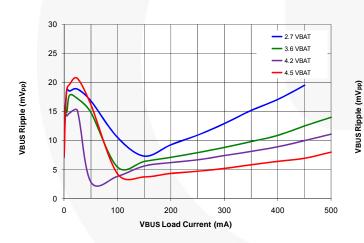


Figure 29. Output Ripple vs. V<sub>BAT</sub>

Figure 28. Boost PFM Waveform

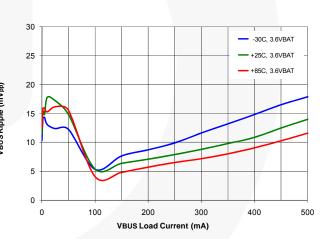


Figure 30. Output Ripple vs. Temperature

### **Boost Mode Typical Characteristics**

Unless otherwise specified, using circuit of Figure 1, V<sub>BAT</sub>=3.6 V, T<sub>A</sub>=25°C.

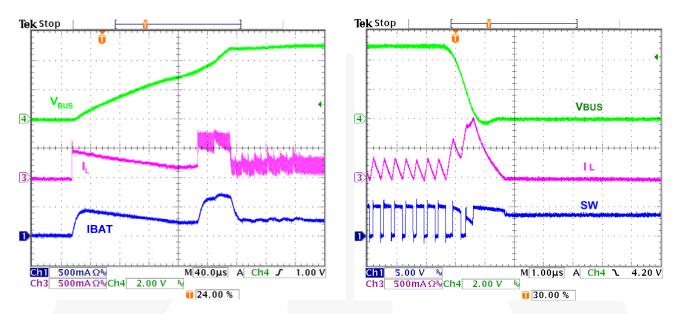


Figure 31. Startup, 3.6  $V_{BAT}$ , 44  $\Omega$  Load, Additional 10  $\mu F$ , X5R Across  $V_{BUS}$ 

Figure 32. V<sub>BUS</sub> Fault Response, 3.6 V<sub>BAT</sub>

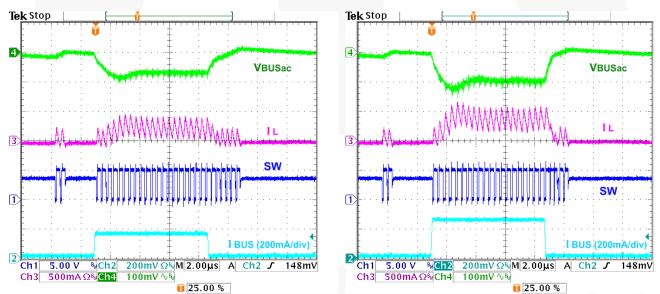


Figure 33. Load Transient, 5-155-5 mA, t<sub>R</sub>=t<sub>F</sub>=100 ns

Figure 34. Load Transient, 5-255-5 mA, t<sub>R</sub>=t<sub>F</sub>=100 ns

### **Circuit Description / Overview**

When charging batteries with a current-limited input source, such as USB, a switching charger's high efficiency over a wide range of output voltages minimizes charging time.

FAN5401X combines a highly integrated synchronous buck regulator for charging with a synchronous boost regulator, which can supply 5 V to USB On-The-Go (OTG) peripherals. The regulator employs synchronous rectification for both the charger and boost regulators to maintain high efficiency over a wide range of battery voltages and charge states.

The FAN5401X has three operating modes:

- Charge Mode: Charges a single-cell Li-ion or Li-polymer battery.
- Boost Mode: Provides 5 V power to USB-OTG with an integrated synchronous rectification boost regulator using the battery as input.
- High-Impedance Mode:
   Both the boost and charging circuits are OFF in this mode. Current flow from VBUS to the battery or from the battery to VBUS is blocked in this mode. This mode consumes very little current from VBUS or the battery.

Note: Default settings are denoted by **bold typeface**.

### **Charge Mode**

In Charge Mode, FAN5401X employs four regulation loops:

- Input Current: Limits the amount of current drawn from VBUS. This current is sensed internally and can be programmed through the I<sup>2</sup>C interface.
- Charging Current: Limits the maximum charging current. This current is sensed using an external R<sub>SENSE</sub> resistor.
- 3. Charge Voltage: The regulator is restricted from exceeding this voltage. As the internal battery voltage rises, the battery's internal impedance and R<sub>SENSE</sub> work in conjunction with the charge voltage regulation to decrease the amount of current flowing to the battery. Battery charging is completed when the voltage across R<sub>SENSE</sub> drops below the I<sub>TERM</sub> threshold.
- Temperature: If the IC's junction temperature reaches 120°C, charge current is reduced until the IC's temperature stabilizes at 120°C.
- An additional loop limits the amount of drop on VBUS to a programmable voltage (V<sub>SP</sub>) to accommodate "special chargers" that limit current to a lower current than might be available from a "normal" USB wall charger.

### **Battery Charging Curve**

If the battery voltage is below  $V_{SHORT}$ , a linear current source pre-charges the battery until  $V_{BAT}$  reaches  $V_{SHORT}$ . The PWM charging circuit is then started and the battery is charged with a constant current if sufficient input power is available. The current slew rate is limited to prevent overshoot.

The FAN5401X is designed to work with a current-limited input source at VBUS. During the current regulation phase of charging,  $I_{\text{INLIM}}$  or the programmed charging current limits the amount of current available to charge the battery and power the system. The effect of  $I_{\text{INLIM}}$  on  $I_{\text{CHARGE}}$  can be seen in Figure 36.

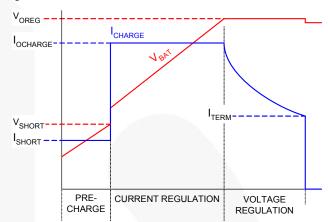


Figure 35. Charge Curve, ICHARGE Not Limited by IINLIM

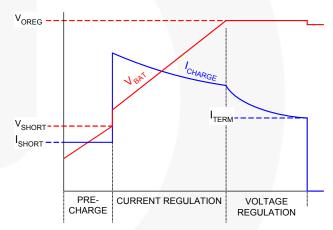


Figure 36. Charge Curve, I<sub>INLIM</sub> Limits I<sub>CHARGE</sub>

Assuming that  $V_{OREG}$  is programmed to the cell's fully charged "float" voltage, the current that the battery accepts with the PWM regulator limiting its output (sensed at VBAT) to  $V_{OREG}$  declines, and the charger enters the voltage regulation phase of charging. When the current declines to the programmed  $I_{TERM}$  value, the charge cycle is complete. Charge current termination can be disabled by resetting the TE bit (REG1[3]).

The charger output or "float" voltage can be programmed by the OREG bits from 3.5 V to 4.44 V in 20 mV increments, as shown in Table 3.

Table 3. OREG Bits (OREG[7:2]) vs. Charger  $V_{OUT}$  ( $V_{OREG}$ ) Float Voltage

(V <sub>OREG</sub> ) FI	oat vo	oitage
Decimal	Hex	VOREG
0	00	3.50
1	01	3.52
2	02	3.54
3	03	3.56
4	04	3.58
5	05	3.60
6	06	3.62
7	07	3.64
8	80	3.66
9	09	3.68
10	0A	3.70
11	0B	3.72
12	0C	3.74
13	0D	3.76
14	0E	3.78
15	0F	3.80
16	10	3.82
17	11	3.84
18	12	3.86
19	13	3.88
20	14	3.90
21	15	3.92
22	16	3.94
23	17	3.96
24	18	3.98
25	19	4.00
26	1A	4.02
27	1B	4.04
28	1C	4.06
29	1D	4.08
30	1E	4.10

	1	
Decimal	Hex	VOREG
32	20	4.14
33	21	4.16
34	22	4.18
35	23	4.20
36	24	4.22
37	25	4.24
38	26	4.26
39	27	4.28
40	28	4.30
41	29	4.32
42	2A	4.34
43	2B	4.36
44	2C	4.38
45	2D	4.40
46	2E	4.42
47	2F	4.44
48	30	4.44
49	31	4.44
50	32	4.44
51	33	4.44
52 34		4.44
53	35	4.44
54	36	4.44
55	37	4.44
56	38	4.44
57	39	4.44
58	3A	4.44
59	3B	4.44
60	3C	4.44
61	3D	4.44
62	3E	4.44

The following charging parameters can be programmed by the host through I<sup>2</sup>C:

**Table 4. Programmable Charging Parameters** 

Parameter	Name	Register
Output Voltage Regulation	Voreg	REG2[7:2]
Battery Charging Current Limit	I <sub>OCHRG</sub>	REG4[6:4]
Input Current Limit	I <sub>INLIM</sub>	REG1[7:6]
Charge Termination Limit	I <sub>TERM</sub>	REG4[2:0]
Weak Battery Voltage	$V_{LOWV}$	REG1[5:4]

A new charge cycle begins when one of the following occurs:

- The battery voltage falls below V<sub>OREG</sub> V<sub>RCH</sub>
- VBUS Power on Reset (POR) clears and the battery voltage is below the weak battery threshold (V<sub>LOWV</sub>).
   This occurs for all versions except the FAN54011.
- CE or HZ\_MODE is reset through I<sup>2</sup>C write to CONTROL1 (R1) register.

### Charge Current Limit (I<sub>OCHARGE</sub>)

Table 5. I<sub>OCHARGE</sub> (REG4 [6:4]) Current as Function of I<sub>OCHARGE</sub> Bits and R<sub>SENSE</sub> Resistor Values

DEC	BIN	HEX V <sub>RSENSE</sub>	V <sub>RSENSE</sub>	I <sub>OCHARG</sub>	<sub>se</sub> (mA)
DEC	DIN	ПЕХ	(mV)	68mΩ	100mΩ
0	000	00	37.4	550	374
1	001	01	44.2	650	442
2	010	02	51.0	750	510
3	011	03	57.8	850	578
4	100	04	71.4	1050	714
5	101	05	78.2	1150	782
6	110	06	91.8	1350	918
7	111	07	98.6	1450	986

### **Termination Current Limit**

Current charge termination is enabled when TE (REG1[3])=1. Typical termination current values are given in Table 6.

Table 6.  $I_{\text{TERM}}$  Current as Function of  $I_{\text{TERM}}$  Bits (REG4[2:0]) and  $R_{\text{SENSE}}$  Resistor Values

	FAN54010-FAN54012			FAN540	13-FAI	N54014
	V <sub>RSENSE</sub>	SE I <sub>TERM</sub> (mA)		V <sub>RSENSE</sub>	I <sub>TERM</sub> (mA)	
ITERM	(mV)	68 mΩ	100 mΩ	(mV)	68 mΩ	100 mΩ
0	3.4	50	34	3.3	49	33
1	6.8	100	68	6.6	97	66
2	10.2	150	102	9.9	146	99
3	13.6	200	136	13.2	194	132
4	17.0	250	170	16.5	243	165
5	20.4	300	204	19.8	291	198
6	23.8	350	238	23.1	340	231
7	27.2	400	272	26.4	388	264

When the charge current falls below I<sub>TERM</sub>, PWM charging stops and the STAT bits change to READY (00) for about 500 ms while the IC determines whether the battery and charging source are still connected. STAT then changes to CHARGE DONE (10), provided the battery and charger are still connected.

### **PWM Controller in Charge Mode**

The IC uses a current-mode PWM controller to regulate the output voltage and battery charge currents. The synchronous rectifier (Q2) has a negative current limit that turns off Q2 at 140 mA to prevent current flow from the battery.

### **Safety Timer**

Section references Figure 41 and Figure 42.

At the beginning of charging, the IC starts a 15-minute timer ( $t_{15\text{MIN}}$ ). When this timer times out, charging is terminated. Writing to any register through I<sup>2</sup>C stops and resets the  $t_{15\text{MIN}}$  timer, which in turn starts a 32-second timer ( $t_{32\text{S}}$ ). Setting the TMR\_RST bit (REG0[7]) resets the  $t_{32\text{S}}$  timer. If the  $t_{32\text{S}}$  timer times out, charging is terminated, the registers are set to their default values, and charging resumes using the default values with the  $t_{15\text{MIN}}$  timer running.

Normal charging is controlled by the host with the  $t_{32S}$  timer running to ensure that the host is alive. Charging with the  $t_{15\text{MIN}}$  timer running is used for charging that is unattended by the host. If the  $t_{15\text{MIN}}$  timer expires, the IC turns off the charger, sets the  $\overline{\text{CE}}$  bit, and indicates a timer fault (110) on the FAULT bits (REG0[2:0]). This sequence prevents overcharge if the host fails to reset the  $t_{32S}$  timer.

### V<sub>BUS</sub> POR / Non-Compliant Charger Rejection

When the IC detects that  $V_{BUS}$  has risen above  $V_{IN(MIN)1}$  (4.4 V), the IC applies a  $100\Omega$  load from VBUS to GND. To clear the VBUS POR (Power-On-Reset) and begin charging, VBUS must remain above  $V_{IN(MIN)1}$  and below VBUS<sub>OVP</sub> for  $t_{VBUS\_VALID}$  (30 ms) before the IC initiates charging. The VBUS validation sequence always occurs before charging is initiated or re-initiated (for example, after a VBUS OVP fault or a  $V_{RCH}$  recharge initiation).

t<sub>VBUS\_VALID</sub> ensures that unfiltered 50/60 Hz chargers and other non-compliant chargers are rejected.

### **USB-Friendly Boot Sequence**

For FAN54010/12/13, NOT FAN54011/14

At VBUS POR, when the battery voltage is above the weak battery threshold (V<sub>LOWV</sub>), the IC operates in accordance with its  $I^2C$  register settings. If  $V_{BAT} < V_{LOWV}$ , the IC sets all registers to their default values and enables the charger using an input current limit controlled by the OTG pin (100 mA if OTG is LOW and 500 mA if OTG is HIGH). This feature can revive a battery whose voltage is too low to ensure reliable host operation. Charging continues in the absence of host communication even after the battery has reached V<sub>OREG</sub>, whose default value is 3.54 V, and the charger remains active until t<sub>15MIN</sub> times out. Once the host processor begins writing to the IC, charging parameters are set by the host, which must continually reset the t<sub>328</sub> timer to continue charging using the programmed charging parameters. If t<sub>32S</sub>.times out, the register defaults are loaded, the FAULT bits are set to 110, STAT is pulsed HIGH, and charging continues with default charge parameters.

The FAN54011 and FAN54014 do not automatically initiate charging at VBUS POR. Instead, they wait for the host to initiate charging through I<sup>2</sup>C commands.

### Input Current Limiting

To minimize charging time without overloading VBUS current limitations, the IC's input current limit can be programmed by the I<sub>INLIM</sub> bits (REG1[7:6]).

**Table 7. Input Current Limit** 

I <sub>INLIM</sub> REG1[7:6]	Input Current Limit
00	100 mA
01	500 mA
10	800 mA
11	No limit

For all versions except the FAN54011/14, the OTG pin establishes the input current limit when  $t_{15MIN}$  is running. For the FAN54011 and FAN54014, no charging occurs automatically at VBUS POR; the input current limit is established by the  $I_{INLIM}$  bits.

### **Flow Charts**

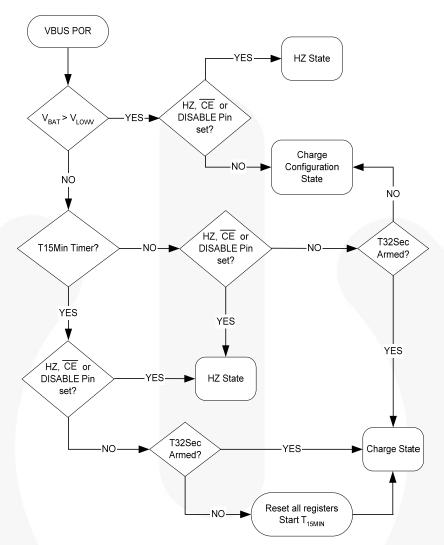
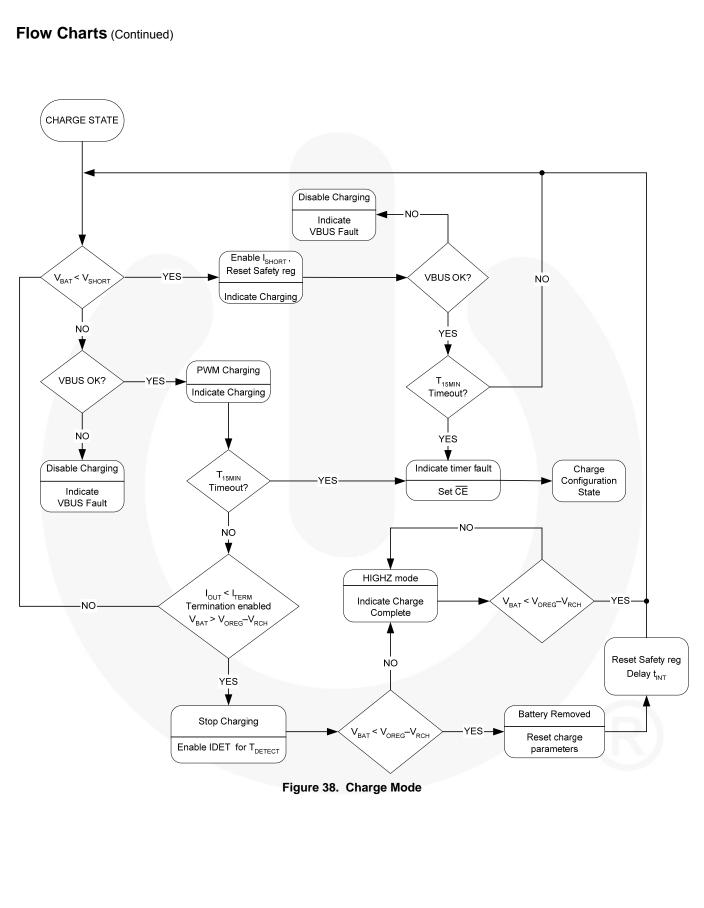


Figure 37. Charger VBUS POR



### Flow Charts (Continued)

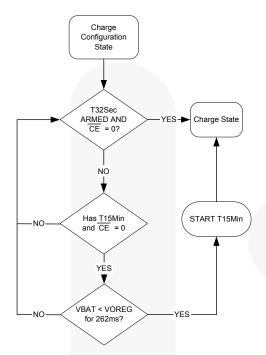


Figure 39. Charge Configuration

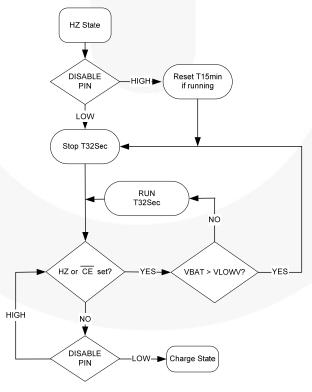


Figure 40. HZ-State

### Flow Charts (Continued)

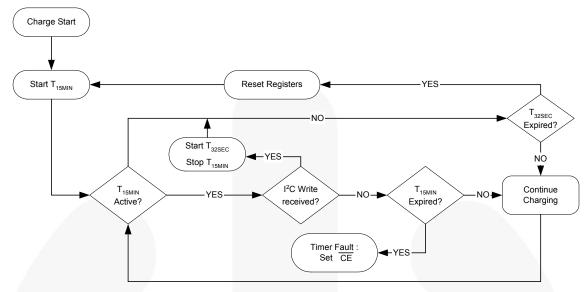


Figure 41. Timer Flow Chart for FAN54010, FAN54012, FAN54013

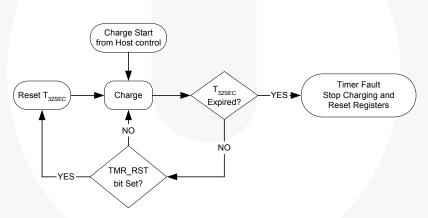


Figure 42. Timer Flow Chart for FAN54011 and FAN54014

### **Special Charger**

FAN54013, FAN54014 Only

The FAN54013 and FAN54014 have additional functionality to limit input current in case a current-limited "special charger" is supplying VBUS. These slowly increase the charging current until either:

I<sub>INLIM</sub> or I<sub>OCHARGE</sub> is reached

or

V<sub>BUS</sub>=V<sub>SP</sub>.

If  $V_{BUS}$  collapses to  $V_{SP}$  when the current is ramping up, the FAN54013 and FAN54014 charge with an input current that keeps  $V_{BUS} = V_{SP}$ . When the  $V_{SP}$  control loop is limiting the charge current, the SP bit (REG5[4]) is set.

Table 8. V<sub>SP</sub> as Function of SP Bits (REG5[2:0])

S			
DEC	BIN	HEX	V <sub>SP</sub>
0	000	00	4.213
1	001	01	4.293
2	010	02	4.373
3	011	03	4.453
4	100	04	4.533
5	101	05	4.613
6	110	06	4.693
7	111	07	4.773

### **Safety Settings**

FAN54013 and FAN54014 Only

The FAN54013 and FAN54014 contain a SAFETY register (REG6) that prevents the values in OREG (REG2[7:2]) and IOCHARGE (REG4[6:4]) from exceeding the values of the VSAFE and ISAFE values.

After  $V_{BAT}$  exceeds  $V_{SHORT}$ , the SAFETY register is loaded with its default value and may be written only before any other register is written. After writing to any other register, the SAFETY register is locked until  $V_{BAT}$  falls below  $V_{SHORT}$ .

The ISAFE (REG6[6:4]) and VSAFE (REG6[3:0]) registers establish values that limit the maximum values of  $I_{OCHARGE}$  and  $V_{OREG}$  used by the control logic. If the host attempts to write a value higher than VSAFE or ISAFE to OREG or IOCHARGE, respectively; the VSAFE, ISAFE value appears as the OREG, IOCHARGE register value, respectively.

Table 9. I<sub>SAFE</sub> (I<sub>OCHARGE</sub> Limit) as Function of ISAFE Bits (REG6[6:4])

ISAFE	ISAFE (REG6[6:4])				
DEC	DIN	HEV	V <sub>RSENSE</sub> (mV)	I <sub>SAFE</sub> (mA)	
DEC	BIN	HEX		68 mΩ	100 mΩ
0	000	00	37.4	550	374
1	001	01	44.2	650	442
2	010	02	51.0	750	510
3	011	03	57.8	850	578
4	100	04	71.4	1050	714
5	101	05	78.2	1150	782
6	110	06	91.8	1350	918
7	111	07	98.6	1450	986

Table 10.  $V_{SAFE}$  ( $V_{OREG}$  Limit) as Function of VSAFE Bits (REG6[3:0])

VSAFE (REG6[3:0])				
DEC	BIN	HEX	Max. OREG (REG2[7:2])	VOREG Max.
0	0000	00	100011	4.20
1	0001	00	100100	4.22
2	0010	01	100101	4.24
3	0011	02	100110	4.26
4	0100	03	100111	4.28
5	0101	04	101000	4.30
6	0110	05	101001	4.32
7	0111	06	101010	4.34
8	1000	07	101011	4.36
9	1001	08	101100	4.38
10	1010	09	101101	4.40
11	1011	0A	101110	4.42
12	1100	0B	101111	4.44
13	1101	0C	110000	4.44
14	1110	0D	110001	4.44
15	1111	0E	110010	4.44

### **Thermal Regulation and Protection**

When the IC's junction temperature reaches  $T_{CF}$  (about 120°C), the charger reduces its output current to 550 mA to prevent overheating. If the temperature increases beyond  $T_{SHUTDOWN}$ ; charging is suspended, the FAULT bits are set to 101, and STAT is pulsed HIGH. In Suspend Mode, all timers stop and the state of the IC's logic is preserved. Charging resumes at programmed current after the die cools to about 120°C.

Additional  $\theta_{JA}$  data points, measured using the FAN5401X evaluation board, are given in Table 11 (measured with  $T_A = 25 ^{\circ} C).$  Note that as power dissipation increases, the effective  $\theta_{JA}$  decreases due to the larger difference between the die temperature and its ambient.

Table 11. FAN5401X Evaluation Board Measured  $\theta_{\text{JA}}$ 

Power (W)	θμα
0.504	54°C/W
0.844	50°C/W
1.506	46°C/W

### Charge Mode Input Supply Protection

### Sleep Mode

When  $V_{\text{BUS}}$  falls below  $V_{\text{BAT}} + V_{\text{SLP}}$ , and  $V_{\text{BUS}}$  is above  $V_{\text{IN(MIN)}}$ , the IC enters Sleep Mode to prevent the battery from draining into VBUS. During Sleep Mode, reverse current is disabled by body switching Q1.

#### Input Supply Low-Voltage Detection

The IC continuously monitors VBUS during charging. If  $V_{\text{BUS}}$  falls below  $V_{\text{IN(MIN)}}$ , the IC:

- Terminates charging
- 2. Pulses the STAT pin, sets the STAT bits to 11, and sets the FAULT bits to 011.

If  $V_{\text{BUS}}$  recovers above the  $V_{\text{IN}(\text{MIN})}$  rising threshold after time  $t_{\text{INT}}$  (about two seconds), the charging process is repeated. This function prevents the USB power bus from collapsing or oscillating when the IC is connected to a suspended USB port or a low-current-capable OTG device.

### **Input Over-Voltage Detection**

When the V<sub>BUS</sub> exceeds VBUS<sub>OVP</sub>, the IC:

- 1. Turns off Q3
- 2. Suspends charging
- 3. Sets the FAULT bits to 001, sets the STAT bits to 11, and pulses the STAT pin.

When  $V_{BUS}$  falls about 150mV below VBUS<sub>OVP</sub>, the fault is cleared and charging resumes after  $V_{BUS}$  is revalidated (see VBUS POR / Non-Compliant Charger Rejection).

### **VBUS Short While Charging**

If VBUS is shorted with a very low impedance while the IC is charging with  $I_{\rm INLIMIT}{=}100$  mA, the IC may not meet datasheet specifications until power is removed. To trigger this condition,  $V_{\rm BUS}$  must be driven from 5 V to GND with a high slew rate. Achieving this slew rate requires a 0  $\Omega$  short to the USB cable less than 10cm from the connector.

### **Charge Mode Battery Detection & Protection**

#### **VBAT Over-Voltage Protection**

The OREG voltage regulation loop prevents  $V_{BAT}$  from overshooting the OREG voltage by more than 50 mV when the battery is removed. When the PWM charger runs with no battery, the TE bit is not set and a battery is inserted that is charged to a voltage higher than  $V_{OREG}$ ; PWM pulses stop. If no further pulses occur for 30 ms, the IC sets the FAULT bits to 100, sets the STAT bits to 11, and pulses the STAT pin.

#### **Battery Detection During Charging**

The IC can detect the presence, absence, or removal of a battery if the termination bit (TE) is set. During normal charging, once  $V_{\text{BAT}}$  is close to  $V_{\text{OREG}}$  and the termination charge current is detected, the IC terminates charging and sets the STAT bits to 10. It then turns on a discharge current,  $I_{\text{DETECT}}$ , for  $t_{\text{DETECT}}$ . If  $V_{\text{BAT}}$  is still above  $V_{\text{OREG}}-V_{\text{RCH}}$ , the battery is present and the IC sets the FAULT bits to 000. If  $V_{\text{BAT}}$  is below  $V_{\text{OREG}}-V_{\text{RCH}}$ , the battery is absent and the IC:

- 1. Sets the registers to their default values.
- 2. Sets the FAULT bits to 111.
- 3. Resumes charging with default values after t<sub>INT</sub>.

#### **Battery Short-Circuit Protection**

If the battery voltage is below the short-circuit threshold ( $V_{SHORT}$ ); a linear current source,  $I_{SHORT}$ , supplies  $V_{BAT}$  until  $V_{BAT} > V_{SHORT}$ .

#### **Battery Detection During Power-up**

For FAN54010 and FAN54013

At VBUS POR, a 5 k $\Omega$  load is applied to VBAT for 500 ms to discharge any residual system capacitance in case the battery is absent. If V<sub>BAT</sub> < V<sub>SHORT</sub>, linear charging commences. When V<sub>BAT</sub> rises above V<sub>SHORT</sub>, PWM charging proceeds with the float voltage (OREG) temporarily set to 4 V. If the battery voltage exceeds 3.7 V within 32 ms of the beginning of PWM charging, the battery is absent. If battery absent is detected:

- 1. High-Impedance Mode is entered.
- FAULT bits are set to 111.
- 3. The t<sub>15MIN</sub> timer is disabled until VBUS is removed.

If  $V_{\text{BAT}}$  remains below 3.7 V during the initial 32 ms period, the float voltage returns to the OREG register setting and PWM charging continues.

### **System Operation with No Battery**

The FAN54012 continues charging after VBUS POR with the default parameters, regulating the  $V_{BAT}$  line to 3.54 V until the host processor issues commands or the 15-minute timer expires. In this way, the FAN54012 can start the system without a battery.

The FAN5401X soft-start function can interfere with the system supply with battery absent. The soft-start activates whenever  $V_{OREG}$ ,  $I_{INLIM}$ , or  $I_{OCHARGE}$  are set from a lower to higher value. During soft-start, the  $I_{IN}$  limit drops to 100 mA for about 1 ms unless  $I_{INLIM}$  is set to 11 (no limit). This could cause the system processor to fail to start. To avoid this behavior, use the following sequence.

- Set the OTG pin HIGH. When VBUS is plugged in, I<sub>INLIM</sub> is set to 500mA until the system processor powers up and can set parameters through I<sup>2</sup>C.
- 2. Program the Safety Register.
- Set I<sub>INLIM</sub> to 11 (no limit).
- 4. Set OREG to the desired value (typically 4.18).
- Reset the IOLEVEL bit, then set IOCHARGE.
- 6. Set I<sub>INLIM</sub> to 500mA if a USB source is connected.

During the initial system startup, while the charger IC is being programmed, the system current is limited to 325 mA for 1ms during steps 4 and 5. This is the value of the soft-start ICHARGE current used when I<sub>INLIM</sub> is set to No Limit.

If the system is powered up without a battery present, the CV bit should be set. When a battery is inserted, the CV bit is cleared.

### **Charger Status / Fault Status**

The STAT pin indicates the operating condition of the IC and provides a fault indicator for interrupt driven systems.

**Table 12. STAT Pin Function** 

EN_STAT	Charge State	STAT Pin
0	X	OPEN
Х	Normal Conditions	OPEN
1	Charging	LOW
Х	Fault (Charging or Boost)	128 µs Pulse, then OPEN

The FAULT bits (R0[2:0]) indicate the type of fault in Charge Mode (see *Table 13*).

Table 13. Fault Status Bits During Charge Mode

F	Fault Bit		Foult Description	
B2	B1	В0	Fault Description	
0	0	0	Normal (No Fault)	
0	0	1	VBUS OVP	
0	1	0	Sleep Mode	
0	1	1	Poor Input Source	
1	0	0	Battery OVP	
1	0	1	Thermal Shutdown	
1	1	0	Timer Fault	
1	1	1	No Battery	

### **Charge Mode Control Bits**

Setting either HZ\_MODE or CE through I $^2$ C disables the charger and puts the IC into High-Impedance Mode and resets  $t_{32S}$ . If  $V_{BAT} < V_{LOWV}$  while in High-Impedance Mode,  $t_{32S}$  begins running and, when it overflows, all registers (except SAFETY) reset, which enables  $t_{15MIN}$  charging on versions with the 15-minute timer.

When  $t_{15\text{MIN}}$  overflows, the IC sets the  $\overline{\text{CE}}$  bit and the IC enters High-Impedance Mode. If  $\overline{\text{CE}}$  was set by  $t_{15\text{MIN}}$  overflow, a new charge cycle can only be initiated through I<sup>2</sup>C or VBUS POR.

Setting the RESET bit clears all registers. If HZ\_MODE or  $\overline{\text{CE}}$  bits were set when the RESET bit is set, these bits are also cleared, but the  $t_{32S}$  timer is not started, and the IC remains in High-Impedance Mode.

Table 14. FAN54013-14 DISABLE Pin and  $\overline{\text{CE}}$  Bit Functionality

Charging	DISABLE Pin	CE	HZ_MODE
ENABLE	0	0	0
DISABLE	X	1	X
DISABLE	X	Х	1
DISABLE	1	Х	X

Raising the DISABLE pin stops  $t_{32S}$  from advancing, but does not reset it. If the DISABLE pin is raised during  $t_{15\text{MIN}}$  charging, the  $t_{15\text{MIN}}$  timer is reset.

#### **Operational Mode Control**

OPA\_MODE (REG1[0]) and the HZ\_MODE (REG1[1]) bits in conjunction with the FAULT state define the operational mode of the charger.

**Table 15. Operation Mode Control** 

HZ_MODE	OPA_MODE	FAULT	Operation Mode
0	0	0	Charge
0	X	1	Charge Configure
0	1	0	Boost
1	Х	Х	High Impedance

The IC resets the OPA\_MODE bit whenever the boost is deactivated, whether due to a fault or being disabled by setting the HZ MODE bit.

### **Boost Mode**

Boost Mode can be enabled if the IC is in 32-Second Mode with the OTG pin and OPA\_MODE bits as indicated in Table 16. The OTG pin ACTIVE state is 1 if OTG\_PL=1 and 0 when OTG\_PL=0.

If boost is active using the OTG pin, Boost Mode is initiated even if the HZ\_MODE=1. The HZ\_MODE bit overrides the OPA\_MODE bit.

Table 16. Enabling Boost

OTG_EN	OTG Pin	HZ_ MODE	OPA_ MODE	BOOST
1	ACTIVE	X	X	Enabled
Х	Х	0	1	Enabled
X	ACTIVE	X	0	Disabled
0	Χ	1	Х	Disabled
1	ACTIVE	1	1	Disabled
0	ACTIVE	0	0	Disabled

To remain in Boost Mode, the TMR\_RST must be set by the host before the  $t_{32S}$  timer times out. If  $t_{32S}$  times out in Boost Mode; the IC resets all registers, pulses the STAT pin, sets the FAULT bits to 110, and resets the BOOST bit. VBUS POR or reading R0 clears the fault condition.

#### **Boost PWM Control**

The IC uses a minimum on-time and computed minimum off-time to regulate VBUS. The regulator achieves excellent transient response by employing current-mode modulation. This technique causes the regulator to exhibit a load line. During PWM Mode, the output voltage drops slightly as the input current rises. With a constant  $V_{BAT}$ , this appears as a constant output resistance.

The "droop" caused by the output resistance when a load is applied allows the regulator to respond smoothly to load transients with no undershoot from the load line. This can be seen in Figure 33 and Figure 43.

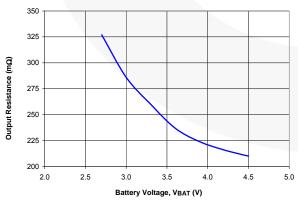


Figure 43. Output Resistance (ROUT)

 $V_{BUS}$  as a function of  $I_{LOAD}$  can be computed when the regulator is in PWM Mode (continuous conduction) as:

$$V_{OUT} = 5.07 - R_{OUT} \bullet I_{LOAD}$$
 EQ. 1

At V<sub>BAT</sub>=3.3 V, and I<sub>LOAD</sub>=200 mA, V<sub>BUS</sub> would drop to:

$$V_{OUT} = 5.07 - 0.26 \cdot 0.2 = 5.018V$$
 EQ. 1A

At V<sub>BAT</sub>=2.7 V, and I<sub>LOAD</sub>=200 mA, V<sub>BUS</sub> would drop to:

$$V_{OUT} = 5.07 - 0.327 \cdot 0.2 = 5.005V$$
 EQ. 1B

#### **PFM Mode**

If  $V_{BUS}$  > VREF<sub>BOOST</sub> (nominally 5.07 V) when the minimum off-time has ended, the regulator enters PFM Mode. Boost pulses are inhibited until  $V_{BUS}$  < VREF<sub>BOOST</sub>. The minimum on-time is increased to enable the output to pump up sufficiently with each PFM boost pulse. Therefore the regulator behaves like a constant on-time regulator, with the bottom of its output voltage ripple at 5.07 V in PFM Mode.

**Table 17. Boost PWM Operating States** 

Mode	Description	Invoked When
LIN	Linear Startup	$V_{BAT} > V_{BUS}$
SS	Boost Soft-Start	V <sub>BUS</sub> < V <sub>BST</sub>
BST	Boost Operating Mode	V <sub>BAT</sub> > UVLO <sub>BST</sub> and SS Completed

### Startup

When the boost regulator is shut down, current flow is prevented from  $V_{\text{BUS}}$ , to  $V_{\text{BUS}}$ , as well as reverse flow from  $V_{\text{RUS}}$  to  $V_{\text{RAT}}$ .

#### **LIN State**

When EN rises, if  $V_{BAT}$  > UVLO<sub>BST</sub>, the regulator first attempts to bring PMID within 400mV of  $V_{BAT}$  using an internal 450 mA current source from VBAT (LIN State). If PMID has not achieved  $V_{BAT}$  – 400mV after 560  $\mu$ s, a FAULT state is initiated

#### SS State

When PMID >  $V_{BAT}-400$  mV, the boost regulator begins switching with a reduced peak current limit of about 50% of its normal current limit. The output slews up until  $V_{BUS}$  is within 5% of its setpoint; at which time, the regulation loop is closed and the current limit is set to 100%.

If the output fails to achieve 95% of its setpoint (V<sub>BST</sub>) within 128  $\mu s$ , the current limit is increased to 100%. If the output fails to achieve 95% of its setpoint after this second  $384 \mu s$  period, a fault state is initiated.

#### **BST State**

This is the normal operating mode of the regulator. The regulator uses a minimum  $t_{\text{OFF}}\text{-minimum}\ t_{\text{ON}}\ \text{modulation}$  scheme. The minimum  $t_{\text{OFF}}$  is proportional to  $\frac{V_{\text{IN}}}{V_{\text{OUT}}}$ , which

keeps the regulator's switching frequency reasonably constant in CCM.  $t_{ON(MIN)}$  is proportional to  $V_{BAT}$  and is a higher value if the inductor current reached 0 before  $t_{OFF(MIN)}$  in the prior cycle.

To ensure the VBUS does not pump significantly above the regulation point, the boost switch remains off as long as  $FB > V_{RFF}$ .

#### **Boost Faults**

If a BOOST fault occurs:

- 1. The STAT pin pulses.
- 2. OPA\_MODE bit is reset.
- 3. The power stage is in High-Impedance Mode.
- 4. The FAULT bits (REG0[2:0]) are set per Table 18.

#### **Restart After Boost Faults**

If boost was enabled with the OPA\_MODE bit and OTG\_EN=0, Boost Mode can only be enabled through subsequent I<sup>2</sup>C commands since OPA\_MODE is reset on boost faults. If OTG\_EN=1 and the OTG pin is still ACTIVE (see Table 16), the boost restarts after a 5.2 ms delay, as shown in Figure 44. If the fault condition persists, restart is attempted every 5 ms until the fault clears or an I<sup>2</sup>C command disables the boost.

Table 18. Fault Bits During Boost Mode

Fa	ault Bit		Coult Description
B2	В1	В0	Fault Description
0	0	0	Normal (no fault)
0	0	1	V <sub>BUS</sub> > VBUS <sub>OVP</sub>
0	1	0	$V_{\text{BUS}}$ fails to achieve the voltage required to advance to the next state during soft-start or sustained (>50 µs) current limit during the BST state.
0	1	1	V <sub>BAT</sub> < UVLO <sub>BST</sub>
1	0	0	N/A: This code does not appear.
1	0	1	Thermal shutdown
1	1	0	Timer fault; all registers reset.
1	1	1	N/A: This code does not appear.

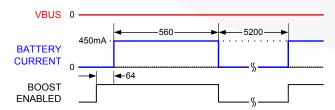


Figure 44. Boost Response Attempting to Start into V<sub>BUS</sub> Short Circuit (Times in μs)

#### **VREG Pin**

The VREG pin on FAN54010, FAN54011, and FAN54012 provides a voltage protected from over-voltage surges on VBUS, which can be used to run auxiliary circuits. This voltage is essentially a current-limited replica of PMID. The maximum voltage on this node is 5.9 V.

FAN54013 and FAN54014 provide a 1.8 V regulated output on this pin, which can be disabled through  $I^2C$  by setting the DIS\_VREG bit (REG5[6]). VREG can supply up to 2 mA. This circuit, which is powered from PMID, is enabled only when PMID > V\_BAT and does not drain current from the battery. During boost, V\_REG is off. It is also off when the HZ\_MODE bit (REG1[1])=1.

### Monitor Register (Reg10H)

Additional status monitoring bits enable the host processor to have more visibility into the status of the IC. The monitor bits are real-time status indicators and are not internally debounced or otherwise time qualified.

The state of the MONITOR register bits listed in High-Impedance Mode are only valid when  $V_{\text{BUS}}$  is valid.

### Table 19. MONITOR Register Bit Definitions

DIT#	NI A BATT	9	A ative When								
BIT#	NAME	0	1	Active When							
MONITO	MONITOR Address 10H										
7	ITEDM CMD	V <sub>CSIN</sub> - V <sub>BAT</sub> < V <sub>ITERM</sub>	V <sub>CSIN</sub> - V <sub>BAT</sub> > V <sub>ITERM</sub>	Charging with TE=1							
7	ITERM_CMP	V <sub>CSIN</sub> – V <sub>BAT</sub> < 1 mV	V <sub>CSIN</sub> – V <sub>BAT</sub> > 1 mV	Charging with TE=0							
		V <sub>BAT</sub> < V <sub>SHORT</sub>	V <sub>BAT</sub> > V <sub>SHORT</sub>	Charging							
6	VBAT_CMP	$V_{BAT} < V_{LOWV}$	$V_{BAT} > V_{LOWV}$	High-Impedance Mode							
		V <sub>BAT</sub> < UVLO <sub>BST</sub>	V <sub>BAT</sub> > UVLO <sub>BST</sub>	Boosting							
5	LINCHG	Linear Charging Not Enabled	Linear Charging Enabled	Charging							
4	T_120	T <sub>J</sub> < 120°C	T <sub>J</sub> > 120°C								
3	ICHG	Charging Current Controlled by I <sub>CHARGE</sub> Control Loop	Charging Current Not Controlled by I <sub>CHARGE</sub> Control Loop	Charging							
2	IBUS	I <sub>BUS</sub> Limiting Charging Current	Charge Current Not Limited by I <sub>BUS</sub>	Charging							
1	VBUS_VALID	V <sub>BUS</sub> Not Valid	V <sub>BUS</sub> is Valid	V <sub>BUS</sub> > V <sub>BAT</sub>							
0	CV	Constant Current Charging	Constant Voltage Charging	Charging							

### I<sup>2</sup>C Interface

The FAN5401X's serial interface is compatible with Standard, Fast, Fast Plus, and High-Speed Mode I<sup>2</sup>C-Bus® specifications. The SCL line is an input and the SDA line is a bi-directional open-drain output; it can only pull down the bus when active. The SDA line only pulls LOW during data reads and signaling ACK. All data is shifted in MSB (bit 7) first.

### **Slave Address**

### Table 20. I<sup>2</sup>C Slave Address Byte

Part Types	7	6	5	4	3	2	1	0
FAN54010-FAN54014	1	1	0	1	0	1	1	$R/\overline{W}$

In hex notation, the slave address assumes a 0 LSB. The hex slave address is D6H the family of parts.

### **Bus Timing**

As shown in Figure 45, data is normally transferred when SCL is LOW. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.

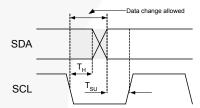


Figure 45. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a START condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH, as shown in Figure 46.

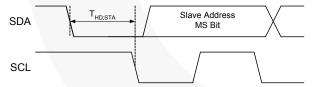


Figure 46. Start Bit

A transaction ends with a STOP condition, which is defined as SDA transitioning from 0 to 1 with SCL HIGH, as shown in Figure 47.

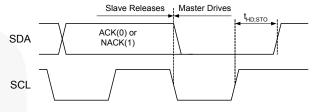


Figure 47. Stop Bit

During a read from the FAN5401X (Figure 50), the master issues a Repeated Start after sending the register address and before resending the slave address. The Repeated Start is a 1-to-0 transition on SDA while SCL is HIGH, as shown in Figure 48.

### High-Speed (HS) Mode

The protocols for High-Speed (HS), Low-Speed (LS), and Fast-Speed (FS) Modes are identical except the bus speed for HS Mode is 3.4 MHz. HS Mode is entered when the bus master sends the HS master code 00001XXX after a start condition. The master code is sent in Fast or Fast Plus Mode (less than 1MHz clock); slaves do not ACK this transmission.

The master then generates a repeated start condition (Figure 48) that causes all slaves on the bus to switch to HS Mode. The master then sends I<sup>2</sup>C packets, as described above, using the HS Mode clock rate and timing.

The bus remains in HS Mode until a stop bit (Figure 47) is sent by the master. While in HS Mode, packets are separated by repeated start conditions (Figure 48).

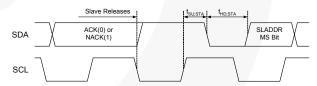


Figure 48. Repeated Start Timing

#### **Read and Write Transactions**

The figures below outline the sequences for data read and write. Bus control is signified by the shading of the packet,

defined as

Master Drives Bus and Slave Drives Bus All addresses and data are MSB first.

Table 21. Bit Definitions for Figure 49, Figure 50

	3, 3
Symbol	Definition
S	START, see Figure 46.
А	ACK. The slave drives SDA to 0 to acknowledge the preceding packet.
Ā	NACK. The slave sends a 1 to NACK the preceding packet.
R	Repeated START, see Figure 48
Р	STOP, see Figure 47

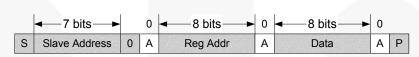


Figure 49. Write Transaction



Figure 50. Read Transaction

### **Register Descriptions**

FAN54010-FAN54012 have seven user-accessible registers; FAN54013 and FAN54014 have an additional two registers, defined in Table 22.

Table 22. I<sup>2</sup>C Register Address

IC	Regis	Address Bits								
IC	Name	REG#	7	6	5	4	3	2	1	0
	CONTROL0	0	0	0	0	0	0	0	0	0
	CONTROL1	1	0	0	0	0	0	0	0	1
	OREG	2	0	0	0	0	0	0	1	0
ALL	IC_INFO	03 or 3BH	0	0	0	0	0	0	1	1
	IBAT	4	0	0	0	0	0	1	0	0
FAN54013 and FAN54014	SP_CHARGER	5	0	0	0	0	0	1	0	1
FAIND4013 and FAIND4014	SAFETY	6	0	0	0	0	0	1	1	0
ALL	MONITOR	10H	0	0	0	0	1	0	1	0

### **Table 23. Register Bit Definitions**

This table defines the operation of each register bit for all IC versions. Default values are in **bold** text.

Bit	Name	Value	Туре		Description			
CONTROL0				Register Address: 00	Default Value=X1XX 0XXX			
7	TMR RST		W	Writing a 1 resets the t <sub>32S</sub> timer; writing a 0 has no effect				
7	OTG	1	R	Returns the OTG pin level (1	=HIGH)			
6 EN_STAT	0	R/W	Prevents STAT pin from goin enunciate faults	ng LOW during charging; STAT pin still pulses to				
	1		Enables STAT pin LOW wh	en IC is charging				
	00	R	Ready					
5:4	STAT	01		Charge in progress	harge in progress			
5.4	SIAI	10		Charge done				
		11		Fault				
3	BOOST	0	R	IC is not in Boost Mode				
3	воозт	1		IC is in Boost Mode				
2:0	FAULT		R	Fault status bits: for Charge I	Mode, see Table 13; for Boost Mode, see Table 18			
CONT	ROL1			Register Address: 01	Default Value=0011 0000 (30H)			
7:6	I <sub>INLIM</sub>		R/W	Input current limit, see Table	7			
		00	R/W	3.4 V				
5:4	$V_{LOWV}$	01		3.5 V	Weak battery voltage threshold			
J. <del>4</del>	<b>V</b> LOWV	10		3.6 V	vveak battery voltage tilleshold			
		11		3.7 V				
3	TE	0	R/W	Disable charge current term	mination			
J	1 -	1		Enable charge current termin	nation			
2	<u></u>	0	R/W	Charger enabled				
2	CE	1		Charger disabled				

### **Table 23. Register Bit Definitions**

This table defines the operation of each register bit for all IC versions. Default values are in **bold** text.

Bit	Name	Value	Туре	Description				
1	HZ MODE	0	R/W	Not High-Impedance Mode				
1		1		High-Impedance Mode	Soc Toble 16			
0		0	R/W	Charge Mode See Table 16				
0	OPA_MODE	1		Boost Mode				
OREG	i			Register Address: 02	Default Value=0000 1010 (0AH)			
7:2	OREG		R/W	Charger output "float" voltage; programma increments; <b>defaults to 000010 (3.54 V)</b> ,				
4	OTC DI	0	R/W	OTG pin active LOW				
1	OTG_PL	1		OTG pin active HIGH				
0	OTO EN	0	R/W	Disables OTG pin				
0	OTG_EN	1		Enables OTG pin				
IC_INF	=O			Register Address: 03 or 3B	Default Value=100X X100			
7:5	Vendor Code	100	R	Identifies Fairchild Semiconductor as the	IC supplier			
4:2	PN		R	Part number bits, see the Ordering Info or	n page 1			
1:0	REV	00	R	IC Revision, revision 1.X, where X is the c	decimal of these three bits			
IBAT				Register Address: 04	Default Value=1000 1001 (89H)			
7	RESET	1	W	Writing a 1 resets charge parameters, exc defaults: writing a 0 has no effect; read ref				
6:4	IOCHARGE	Table 5	R/W	Programs the maximum charge current, s	see Table 5			
3	Reserved	1	R	Unused				
2:0	ITERM	Table 6	R/W	Sets the current used for charging termina	Sets the current used for charging termination, see Table 6			
SP_CI	HARGER (FAN5	4013-14)	<u>I</u>	Register Address: 05	Default Value=001X X100			
7	Reserved	0	R	Unused				
_	DIG VIDEO	0	R/W	1.8 V regulator is ON				
6	DIS_VREG	1		1.8 V regulator is OFF				
		0	R/W	Output current is controlled by IOCHARGI	E bits			
5	IO_LEVEL	1		Voltage across $R_{SENSE}$ for output current of $R_{SENSE}$ =68 m $\Omega$ , 221 mA for 100 m $\Omega$ )	control is set to 22.1 mV (325 mAfor			
_		0	R	Special charger is not active (V <sub>BUS</sub> is able	to stay above V <sub>SP</sub> )			
4	SP	1		Special charger has been detected and V <sub>BUS</sub> is being regulated to V <sub>SP</sub>				
_		0	R	DISABLE pin is LOW				
3	EN_LEVEL	1		DISABLE pin is HIGH				
2:0	VSP	Table 8	R/W	Special charger input regulation voltage, s	see Table 8			
SAFE	TY (FAN54013-1	14)		Register Address: 06	Default Value=0100 0000 (40H)			
7	Reserved	0	R	Bit disabled and always returns 0 when re	ead back			
6:4	ISAFE	Table 9	R/W	Sets the maximum locharge value used by the control circuit, see Table 9				
3:0	VSAFE	Table 10	R/W	Sets the maximum V <sub>OREG</sub> used by the con	ntrol circuit, see Table 10			
MONI	TOR			Register Address: 10H (16)	See Table 19			
			R	ITERM comparator output, 1 when VRSE				
7	ITERM_CMP				TIOE - TIEI WITCHCHOO			
	VBAT_CMP	Table 19	R	Output of VBAT comparator	THE THE TOTAL CONTROL			

### Table 23. Register Bit Definitions

This table defines the operation of each register bit for all IC versions. Default values are in **bold** text.

Bit	Name	Value	Туре	Description
4	T_120		R	Thermal regulation comparator; when=1 and T_145=0, the charge current is limited to 22.1 mV across $R_{\text{SENSE}}$
3	ICHG		R	0 indicates the ICHARGE loop is controlling the battery charge current
2	IBUS		R	0 indicates the IBUS (input current) loop is controlling the battery charge current
1	VBUS_VALID		R	1 indicates VBUS has passed validation and is capable of charging
0	CV		R	1 indicates the constant-voltage loop (OREG) is controlling the charger and all current limiting loops have released

### **PCB Layout Recommendations**

Bypass capacitors should be placed as close to the IC as possible. In particular, the total loop length for CMID should be minimized to reduce overshoot and ringing on the SW, PMID, and VBUS pins. All power and ground pins must be

routed to their bypass capacitors, using top copper whenever possible. Copper area connecting to the IC should be maximized to improve thermal performance if possible.

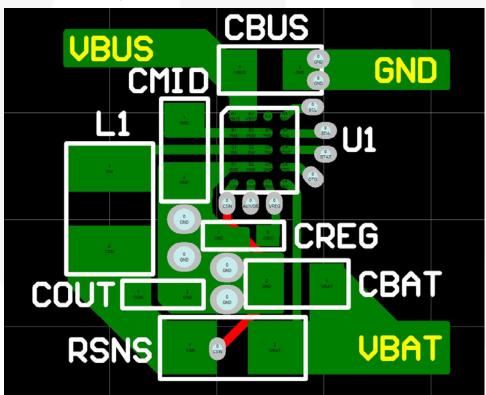
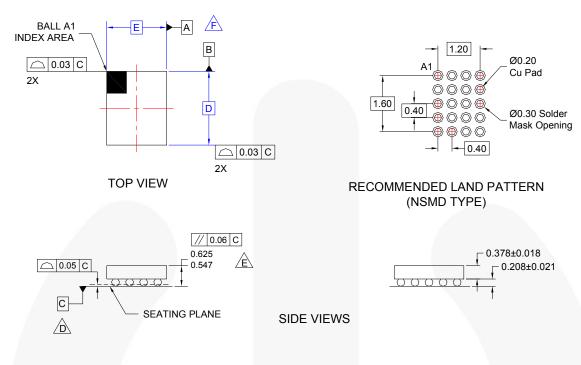
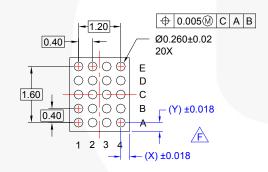


Figure 51. PCB Layout Recommendations

### **Physical Dimensions**





**BOTTOM VIEW** 

#### NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC020AArev2.

Figure 52. 20-Ball WLCSP, 4X5 Array, 0.4 mm Pitch, 250 µm Ball

### **Product-Specific Dimensions**

Product	D	E	X	Y
FAN5401XUCX	1.960 <u>+</u> 0.030	1.870 <u>+</u> 0.030	0.335	0.180

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